



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

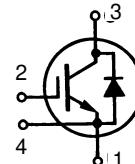
# IGBT with Diode

# IXSN 52N60AU1

## Combi Pack

$V_{CES}$  = 600 V  
 $I_{C25}$  = 80 A  
 $V_{CE(sat)}$  = 3 V

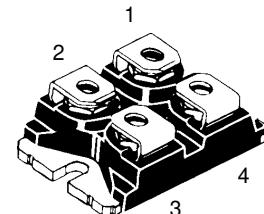
## Short Circuit SOA Capability



Symbol	Test Conditions	Maximum Ratings		
$V_{CES}$	$T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$	600	V	
$V_{CGR}$	$T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$ ; $R_{GE} = 1 \text{ M}\Omega$	600	A	
$V_{GES}$	Continuous	$\pm 20$	V	
$V_{GEM}$	Transient	$\pm 30$	V	
$I_{C25}$	$T_c = 25^\circ\text{C}$	80	A	
$I_{C90}$	$T_c = 90^\circ\text{C}$	40	A	
$I_{CM}$	$T_c = 25^\circ\text{C}$ , 1 ms	160	A	
<b>SSOA (RBSOA)</b>	$V_{GE} = 15 \text{ V}$ , $T_{VJ} = 125^\circ\text{C}$ , $R_G = 22 \Omega$ Clamped inductive load, $L = 30 \mu\text{H}$	$I_{CM} = 80$ @ 0.8 $V_{CES}$	A	
<b>t<sub>sc</sub> (SCSOA)</b>	$V_{GE} = 15 \text{ V}$ , $V_{CE} = 360 \text{ V}$ , $T_{VJ} = 125^\circ\text{C}$ $R_G = 22 \Omega$ , non repetitive	10	$\mu\text{s}$	
$P_c$	$T_c = 25^\circ\text{C}$	250	W	
$V_{ISOL}$	50/60 Hz      t = 1 min	2500	V~	
	$I_{ISOL} \leq 1 \text{ mA}$ t = 1 s	3000	V~	
$T_J$		-55 ... +150	$^\circ\text{C}$	
$T_{JM}$		150	$^\circ\text{C}$	
$T_{stg}$		-55 ... +150	$^\circ\text{C}$	
$M_d$	Mounting torque Terminal connection torque (M4)	1.5/13	Nm/lb.in.	
		1.5/13	Nm/lb.in.	
<b>Weight</b>		30	g	

Symbol	Test Conditions	Characteristic Values		
		( $T_J = 25^\circ\text{C}$ , unless otherwise specified)	min.	typ.
$BV_{CES}$	$I_c = 3 \text{ mA}$ , $V_{GE} = 0 \text{ V}$	600		V
$V_{GE(th)}$	$I_c = 4 \text{ mA}$ , $V_{CE} = V_{GE}$	4		V
$I_{CES}$	$V_{CE} = 0.8 \cdot V_{CES}$ $V_{GE} = 0 \text{ V}$	$T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$		$750 \text{ }\mu\text{A}$ 15 mA
$I_{GES}$	$V_{CE} = 0 \text{ V}$ , $V_{GE} = \pm 20 \text{ V}$			$\pm 100 \text{ nA}$
$V_{CE(sat)}$	$I_c = I_{C90}$ , $V_{GE} = 15 \text{ V}$		3	V

## miniBLOC, SOT-227 B



1 = Emitter ①, 3 = Collector  
 2 = Gate, 4 = Emitter ①

① Either Emitter terminal can be used as Main or Kelvin Emitter

## Features

- International standard package miniBLOC
- Aluminium-nitride isolation
  - high power dissipation
- Isolation voltage 3000 V~
- Low  $V_{CE(sat)}$ 
  - for minimum on-state conduction losses
- Fast Recovery Epitaxial Diode
  - short  $t_{rr}$  and  $I_{RM}$
- Low collector-to-case capacitance (< 50 pF)
  - reduces RFI
- Low package inductance (< 10 nH)
  - easy to drive and to protect

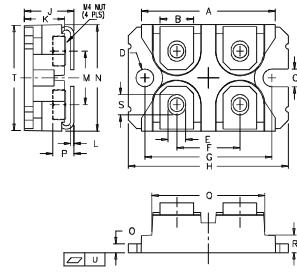
## Applications

- AC motor speed control
- DC servo and robot drives
- DC choppers
- Uninterruptible power supplies (UPS)
- Switch-mode and resonant-mode power supplies

## Advantages

- Space savings
- Easy to mount with 2 screws
- High power density

Symbol	Test Conditions	Characteristic Values		
		( $T_J = 25^\circ\text{C}$ , unless otherwise specified)	min.	typ.
$g_{fs}$	$I_C = I_{C90}$ ; $V_{CE} = 10 \text{ V}$ , Pulse test, $t \leq 300 \mu\text{s}$ , duty cycle $d \leq 2\%$	20	23	S
$C_{ies}$ $C_{oes}$ $C_{res}$	$V_{CE} = 25 \text{ V}$ , $V_{GE} = 0 \text{ V}$ , $f = 1 \text{ MHz}$	4500		pF
		400		pF
		90		pF
$Q_g$ $Q_{ge}$ $Q_{gc}$	$I_C = I_{C90}$ , $V_{GE} = 15 \text{ V}$ , $V_{CE} = 0.5 V_{CES}$	190	250	nC
		45	60	nC
		88	120	nC
$t_{d(on)}$ $t_{ri}$ $t_{d(off)}$ $t_{fi}$ $E_{off}$	<b>Inductive load, <math>T_J = 25^\circ\text{C}</math></b> $I_C = I_{C90}$ , $V_{GE} = 15 \text{ V}$ , $L = 100 \mu\text{H}$ , $V_{CE} = 0.8 V_{CES}$ , $R_G = 2.7 \Omega$ Remarks: Switching times may increase for $V_{CE}$ (Clamp) > $0.8 \cdot V_{CES}$ , higher $T_J$ or increased $R_G$	70		ns
		220		ns
		200		ns
		200		ns
		3.5		mJ
$t_{d(on)}$ $t_{ri}$ $E_{on}$ $t_{d(off)}$ $t_{fi}$ $E_{off}$	<b>Inductive load, <math>T_J = 125^\circ\text{C}</math></b> $I_C = I_{C90}$ , $V_{GE} = 15 \text{ V}$ , $L = 100 \mu\text{H}$ $V_{CE} = 0.8 V_{CES}$ , $R_G = 2.7 \Omega$ Remarks: Switching times may increase for $V_{CE}$ (Clamp) > $0.8 \cdot V_{CES}$ , higher $T_J$ or increased $R_G$	70		ns
		220		ns
		4.7		mJ
		450		ns
		340	600	ns
$R_{thJC}$ $R_{thCK}$			0.50	K/W
		0.05		K/W

**miniBLOC, SOT-227 B**

Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	31.50	31.88	1.240	1.255
B	7.80	8.20	0.307	0.323
C	4.09	4.29	0.161	0.169
D	4.09	4.29	0.161	0.169
E	4.09	4.29	0.161	0.169
F	14.91	15.11	0.587	0.595
G	30.12	30.30	1.186	1.193
H	38.00	38.23	1.496	1.505
J	11.68	12.22	0.460	0.481
K	8.92	9.60	0.351	0.378
L	0.76	0.84	0.030	0.033
M	12.60	12.85	0.496	0.506
N	25.15	25.42	0.990	1.001
O	1.98	2.13	0.078	0.084
P	4.95	5.97	0.195	0.235
Q	26.54	26.90	1.045	1.059
R	3.94	4.42	0.155	0.174
S	4.72	4.85	0.186	0.191
T	24.59	25.07	0.968	0.987
U	-0.05	0.1	-0.002	0.004

**Reverse Diode (FRED)****Characteristic Values** $(T_J = 25^\circ\text{C}$ , unless otherwise specified)

Symbol	Test Conditions	min.	typ.	max.
$V_F$	$I_F = I_{C90}$ , $V_{GE} = 0 \text{ V}$ , Pulse test, $t \leq 300 \mu\text{s}$ , duty cycle $d \leq 2\%$		1.8	V
$I_{RM}$ $t_{rr}$	$I_F = I_{C90}$ , $V_{GE} = 0 \text{ V}$ , $-di_F/dt = 480 \text{ A}/\mu\text{s}$ $V_R = 360 \text{ V}$ $I_F = 1 \text{ A}$ ; $-di/dt = 200 \text{ A}/\mu\text{s}$ ; $V_R = 30 \text{ V}$ $T_J = 125^\circ\text{C}$ $T_J = 25^\circ\text{C}$	19		A
		175		ns
		35	50	ns
$R_{thJC}$			0.80	K/W

Fig.1 Saturation Characteristics

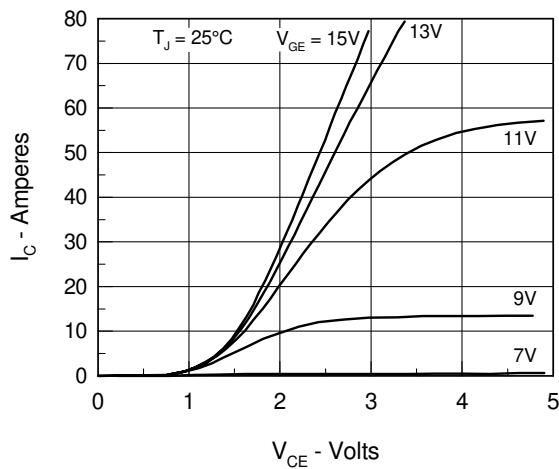


Fig.3 Collector-Emitter Voltage vs. Gate-Emitter Voltage

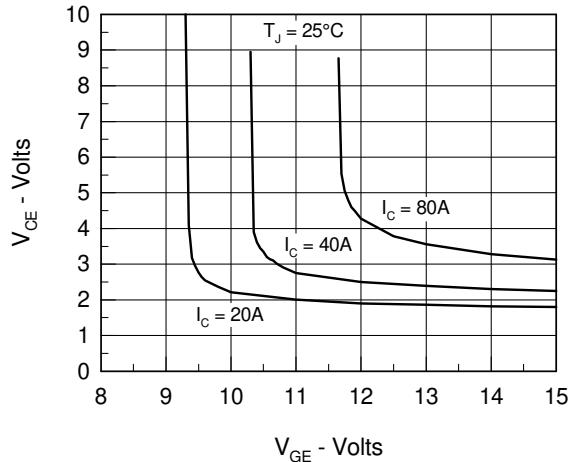


Fig.5 Input Admittance

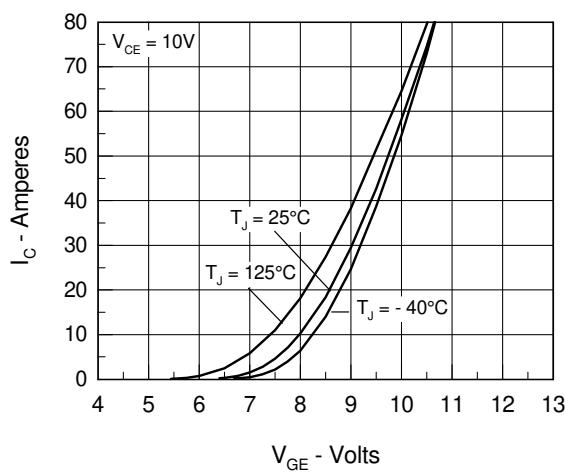


Fig.2 Output Characteristics

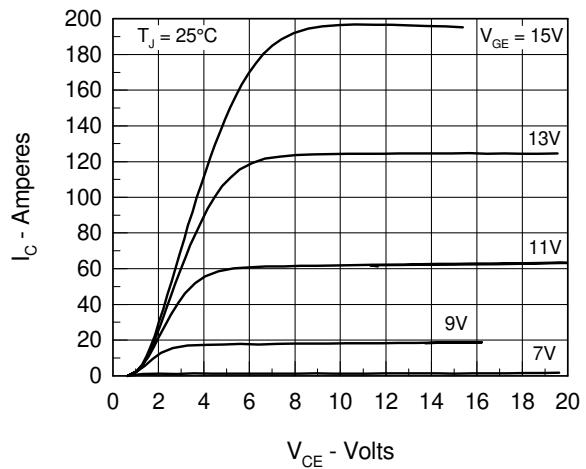


Fig.4 Temperature Dependence of Output Saturation Voltage

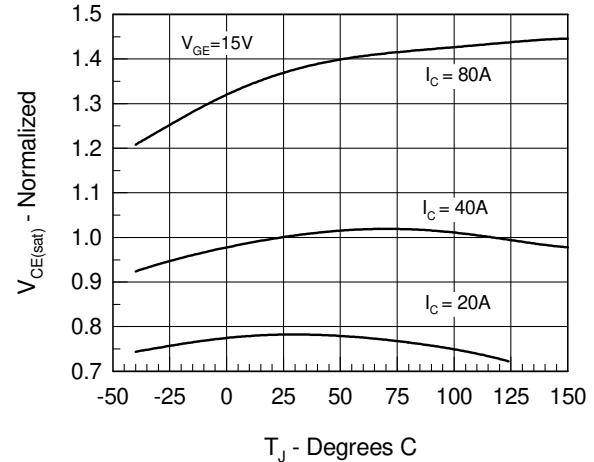


Fig.6 Temperature Dependence of Breakdown and Threshold Voltage

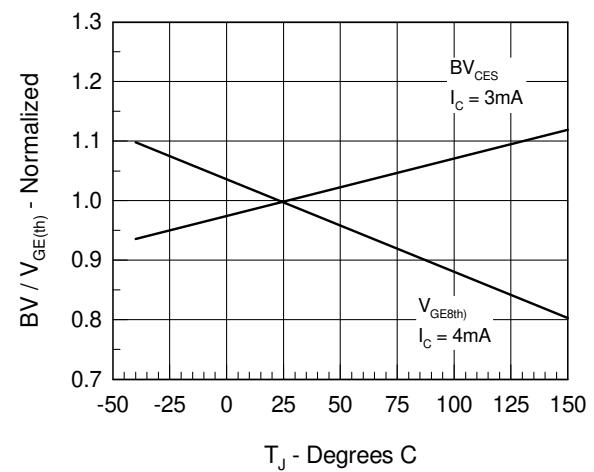


Fig.7 Turn-Off Energy per Pulse and Fall Time on Collector Current

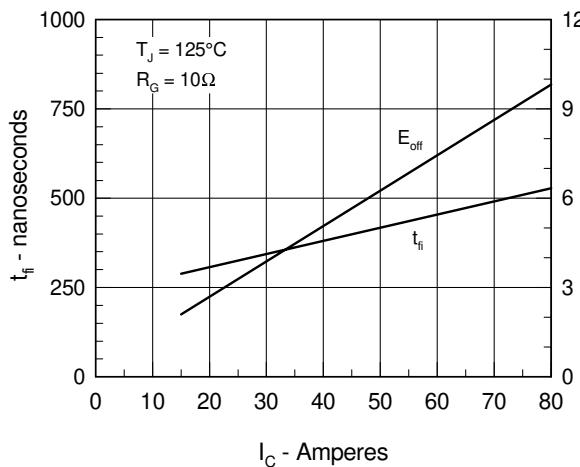


Fig.8 Dependence of Turn-Off Energy Per Pulse and Fall Time on  $R_G$

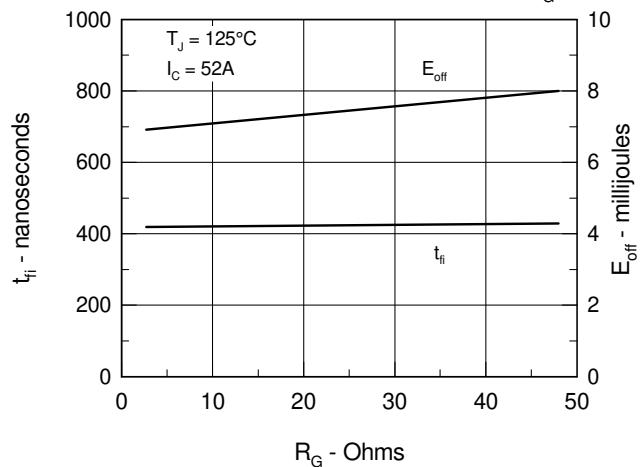


Fig.9 Gate Charge Characteristic Curve

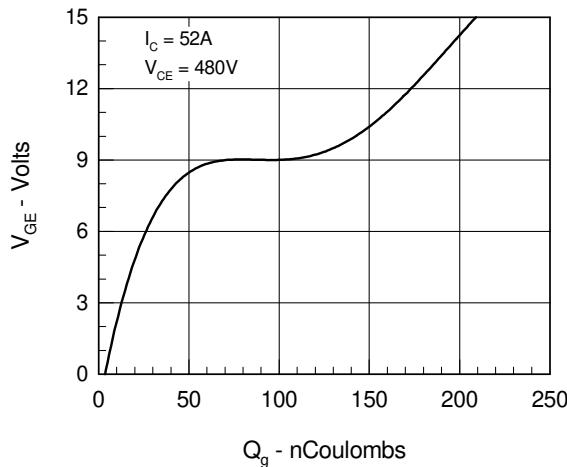


Fig.10 Turn-Off Safe Operating Area

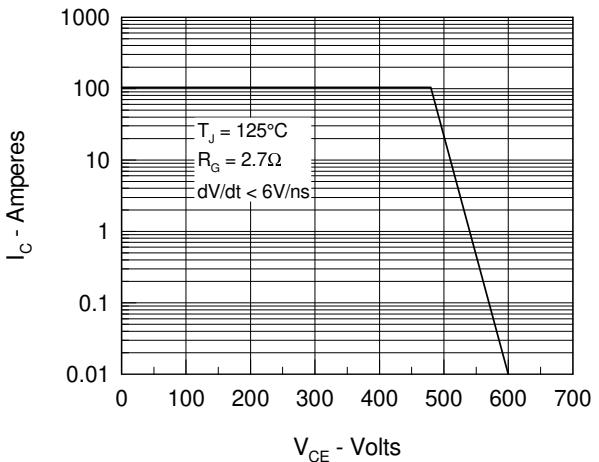
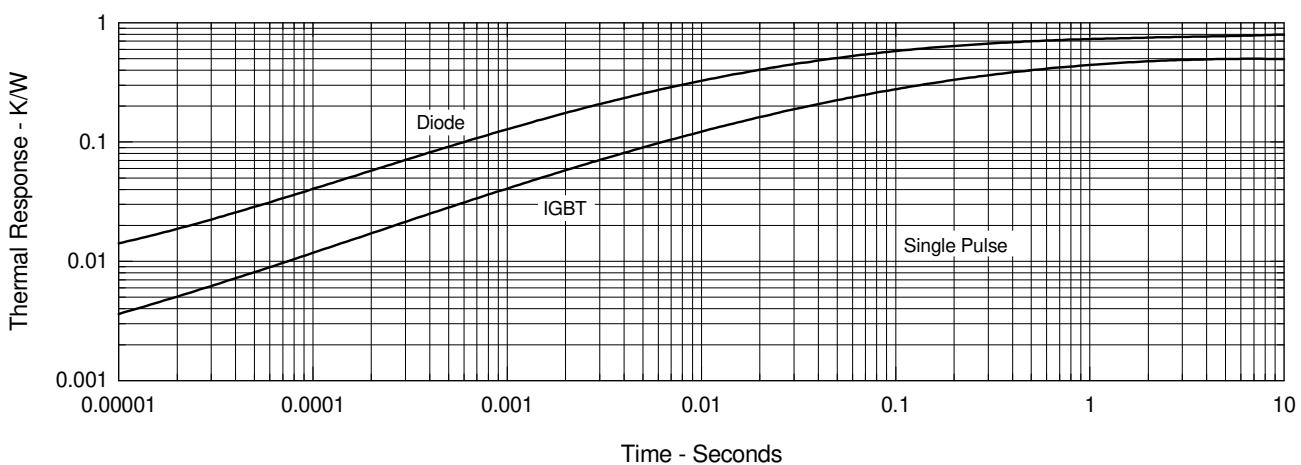


Fig.11 Transient Thermal Impedance



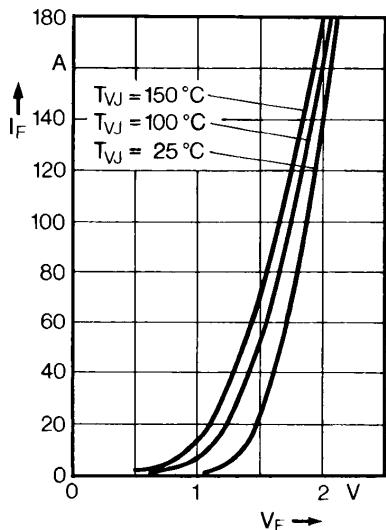


Fig. 12 Forward current versus voltage drop.

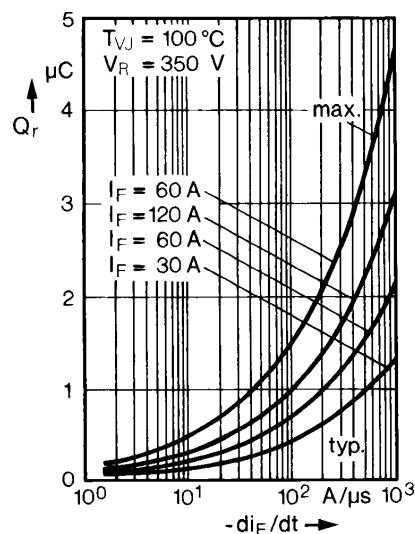


Fig. 13 Recovery charge versus  $-di_F/dt$ .

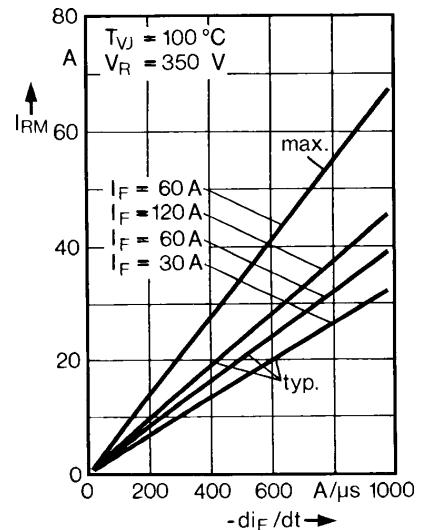


Fig. 14 Peak reverse current versus  $-di_F/dt$ .

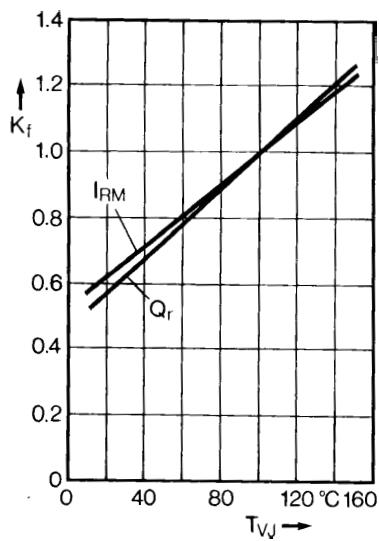


Fig. 15. Dynamic parameters versus junction temperature.

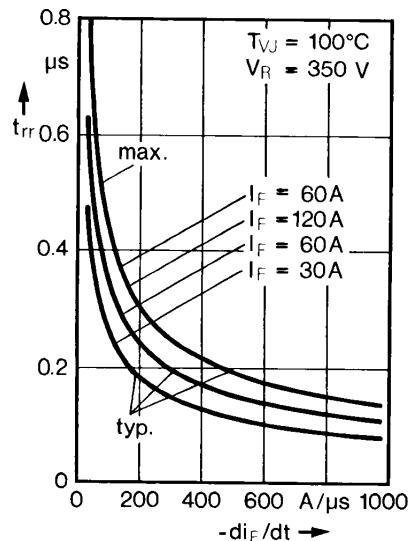


Fig. 16 Recovery time versus  $-di_F/dt$ .

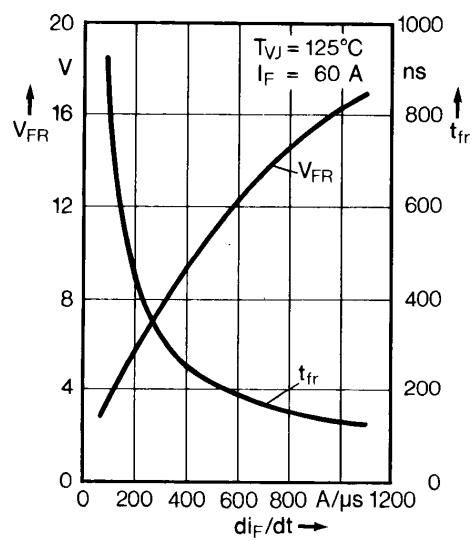


Fig. 17 Peak forward voltage vs.  $di_F/dt$ .

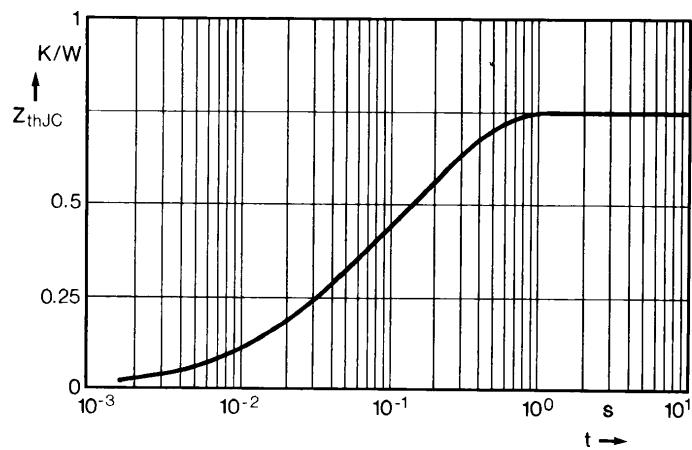


Fig. 18 Transient thermal impedance junction to case.